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 COVER SHEET U.S. DEPARTMENT OF COMMERCE  
 Patent and Trademark Office

Y

To the Honorable Commissioner:

101181194

attached original documents or copy thereof.

## 1 Name of conveying party(ies):

 Chih-Lung Lin  
 Y.C. Chang

10-01-99

## 2 Name and address of receiving party(ies):

 Taiwan Semiconductor Manufacturing Co. Ltd.  
 No. 121 Park Avenue 3  
 Science-Based Industrial Park  
 Hsin-Chu, Taiwan, R.O.C.

 JC525 U.S. PTO  
 09/411173

10/01/99

## 3 Nature of conveyance:

☒ Assignment☐ Merger☐ Security Agreement☐ Change of Name☐ Other:

Execution Date: July 14, 1999

Additional name(s) & address(es) attached ☐ Yes ☒ No

## 4 Application number(s) or patent number(s):

09/411,173

If this document is being filed together with a new application, the execution date of the application is: 07-14-99

A. Patent Application No(s).

B. Patent No(s)

Additional numbers attached? ☐ Yes ☒ No

## 5 Name and address of party to whom correspondence concerning document should be mailed:

 RANDY W. TUNG  
 Tung & Associates  
 838 W. Long Lake Road  
 Suite 120  
 Bloomfield Hills, Michigan 48302

## 6 Total number of applications and patents involved:

1

## 7 Total fee (37 CFR 3.41)

\$40.00

☒ Enclosed☐ Authorized to be charged to deposit account

## 8 Deposit Account Number: 50-0484

(Attach duplicate copy of this page if paying by deposit account)

10/14/1999 TRADE1 00000048 09411173

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## 9 Statement and signature.

*To the best of my knowledge and belief, the foregoing information is true and correct and any attached copy is a true copy of the original document.*

Randy W. Tung

 Name of Person Signing  
 Registration No. 31,311

Signature

October 1, 1999

Date

Total number of pages including cover sheet, attachments, and document: 3

Mail documents to be recorded with required cover sheet information to:

Commissioner of Patents &amp; Trademarks, Box Assignments

Washington, D.C. 20231

PATENT

REEL: 010320 FRAME: 0539

**ASSIGNMENT**

WHEREAS, we, CHIH-LUNG LIN AND Y.C. CHANG have invented certain improvements in APPARATUS AND METHOD FOR CLEANING A POLISHING PAD for which we are about to make application for Letters Patent of the United States; and

WHEREAS, TAIWAN SEMICONDUCTOR MANUFACTURING CO., LTD. of No. 121, Park Avenue 3, Science-Based Industrial Park, Hsin-Chu, Taiwan, R.O.C, is desirous of acquiring the entire right, title and interest in and to said invention;

NOW, THEREFORE, in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt of which is hereby acknowledged, we, CHIH-LUNG LIN AND Y.C. CHANG, by these presents, do hereby sell, assign and transfer unto the said corporation and its assigns, for the territory of the United States of America and all foreign countries, the entire right, title and interest, including all priority rights under the International Convention associated with each country of the Union, in and to said invention as described in the patent application executed by us on the 14<sup>th</sup> day of July, 1999, preparatory to obtaining Letters Patent of the United States thereon, and in and to said application and any Letters Patent that may be granted in pursuance of said application and any divisional, continuation or continuation-in-part application thereof, and in and to any reissue of any such patent, and in and to any patent applications which may be filed on said invention in countries foreign to the United States and any Letters Patent granted

thereon.

We further authorize said corporation to apply for foreign patents on said invention in its own name or through its designees, including subsidiaries, related companies or assignees, under the International Convention or otherwise, and we further agree to execute all papers, including those required for the United States and foreign applications, and to perform such other proper acts as said corporation or its designees the rights herein assigned.

  
CHIH-LUNG LIN

  
Y.S. CHANG

**TUNG & ASSOCIATES**  
**838 W. Long Lake Road**  
**Suite 120**  
**Bloomfield Hills, Michigan 48302**